



# Product Change Notification

## 112337 - 00

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# Product Change Notification

**Change Notification #:** 112337 - 00  
**Change Title:** Intel® True Scale Fabric Host Channel Adapter QLE7340CK, Intel® True Scale Fabric Host Channel Adapter QLE7340LCK, Intel® True Scale Fabric Host Channel Adapter QLE7342CK

**PCN 112337-00, Label, Product Marking**

**QLE734x Product Marking and Labeling Changes for Rebranding**

**Date of Publication:** June 06, 2013

## Key Characteristics of the Change:

Label, Product Marking

## Forecasted Key Milestones:

<b>Date of Samples Availability:</b>	Jun 12, 2013
<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	Jun 12, 2013
<b>Date of First Availability of Post-Conversion Material:</b>	Jun 12, 2013

*The date of "First Availability of Post-Conversion Material" is the projected date that a customer may expect to receive the Post-Conversion Materials. This date is determined by the projected depletion of inventory at the time of the PCN publication. The depletion of inventory may be impacted by fluctuating supply and demand, therefore, although customers should be prepared to receive the Post-Converted Materials on this date, Intel will continue to ship and customers may continue to receive the pre-converted materials until the inventory has been depleted.*

## Description of Change to the Customer:

<b>Affected Product Code</b>	<b>Former Product Code</b>	<b>Product Description</b>
QLE7342CK	IB6413601-03	Intel® True Scale Fabric Host Channel Adapter QLE7342CK
QLE7340CK	IB6413601-04	Intel® True Scale Fabric Host Channel Adapter QLE7340CK
QLE7340LCK	IB6413601-06	Intel® True Scale Fabric Host Channel Adapter QLE7340LCK

## Overview of Changes

The product was rebranded due to the product line acquisition from QLogic\* to Intel completed in 2012.

The rebranding changes affected the following areas:

- The printed circuit board (PCB) silkscreen was revised to meet product marking and compliance requirements
- The product documentation/literature
- Single unit and overpack carton labeling

## Board Change Details

The printed circuit board (PCB) silkscreen was changed to meet product marking and compliance requirements resulting from the product acquisition from QLogic to Intel. There were no electrical changes to the PCB. The following silkscreen changes were made:

- 1) Taiwan BSMI registration number was changed from D32189 to D33025
- 2) Australian C-tick registration number was changed from N1604 to N232
- 3) Korean KC registration number was changed from QLG-QLE7342 (A) to KCC-REM-CPU-QLE7342 (A) to comply with current titling conventions
- 4) TUV Rheinland certification mark was changed to the TUV SUD certification mark
- 5) The manually applied Korean KC and UL registration labels are being eliminated and added to the new PCB silkscreen artwork to simplify the manufacturing process
- 6) The QLogic logo mark was changed to the Intel logo mark

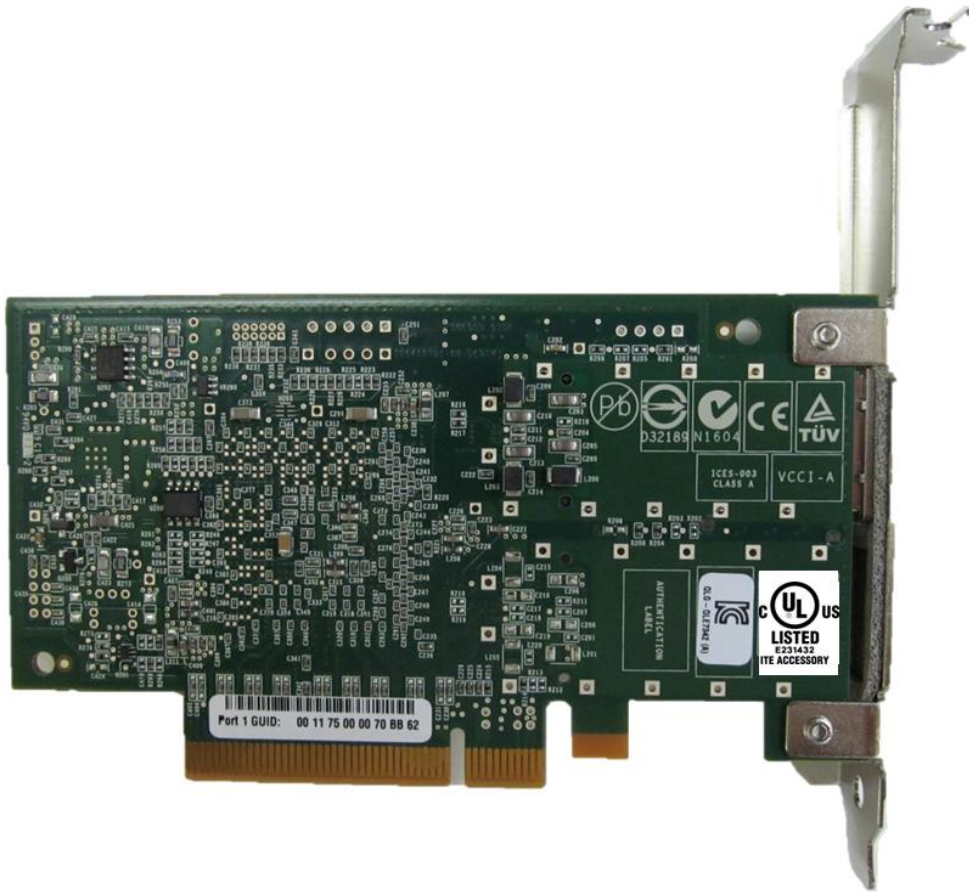
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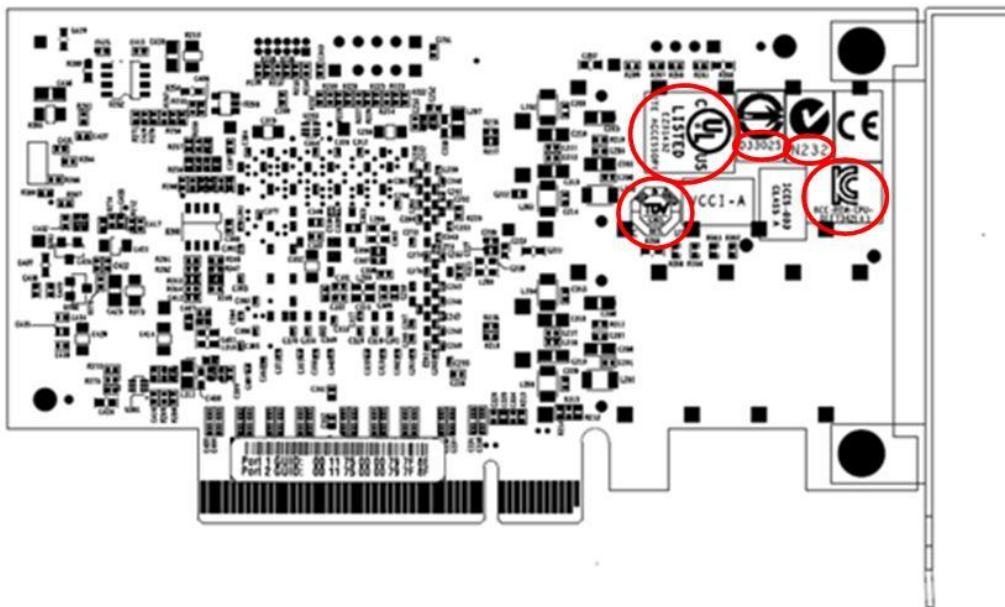
Figure 2. Bottom Side View of Board

From



\* Note: Bracket size varies by product type

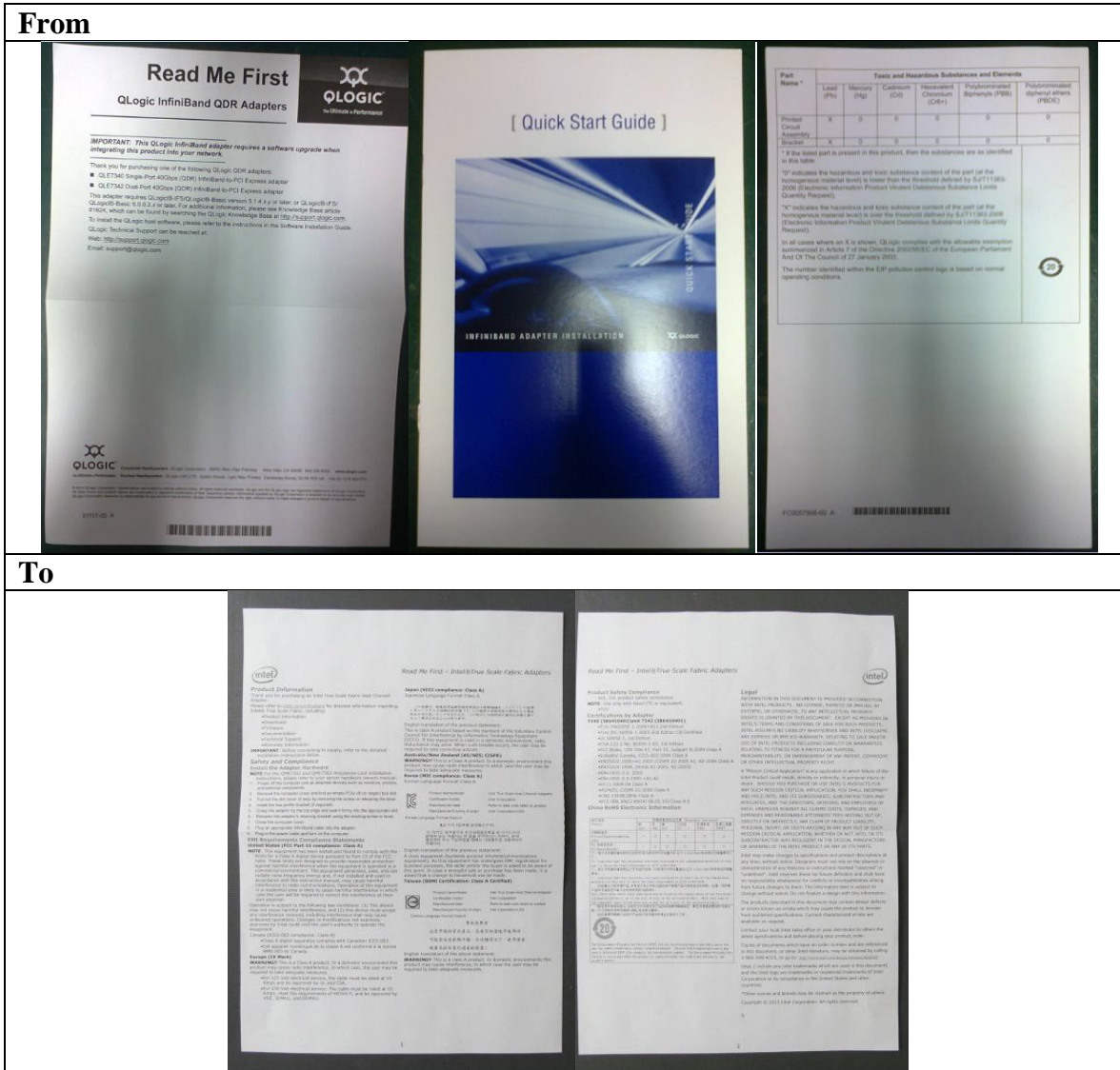
To



# Product Documentation/Literature Change Details

- 1) The QLogic branded Read Me First, Quick Start Guide, and China RoHS Statement were combined into one simplified document.
- 2) The content of compliance statements and certifications were updated as a result of the product acquisition from QLogic to Intel.

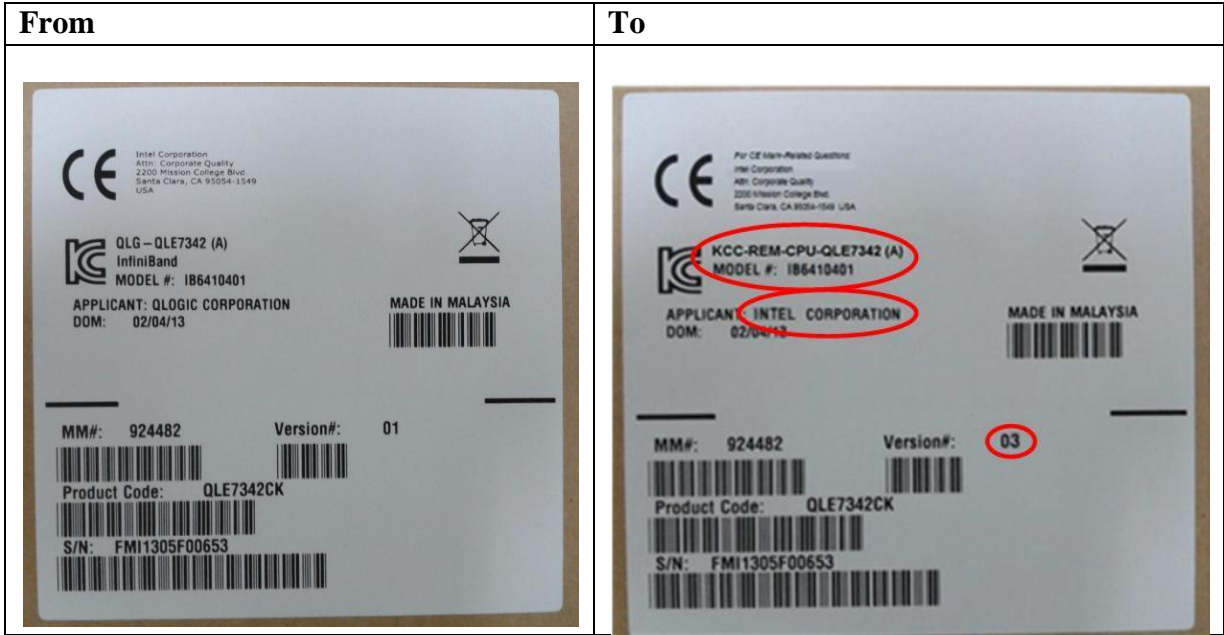
Figure 3. Product Documentation/Literature Changes



### Single Unit Carton Label Change Details

- 1) Updated Intel MM version number for both the barcode and human readable element.
- 2) Updated the Korean KC registration number from QLG-QLE7342 (A) to KCC-REM-CPU-QLE7342 (A) and applicant name from QLOGIC CORPORATION to INTEL CORPORATION.

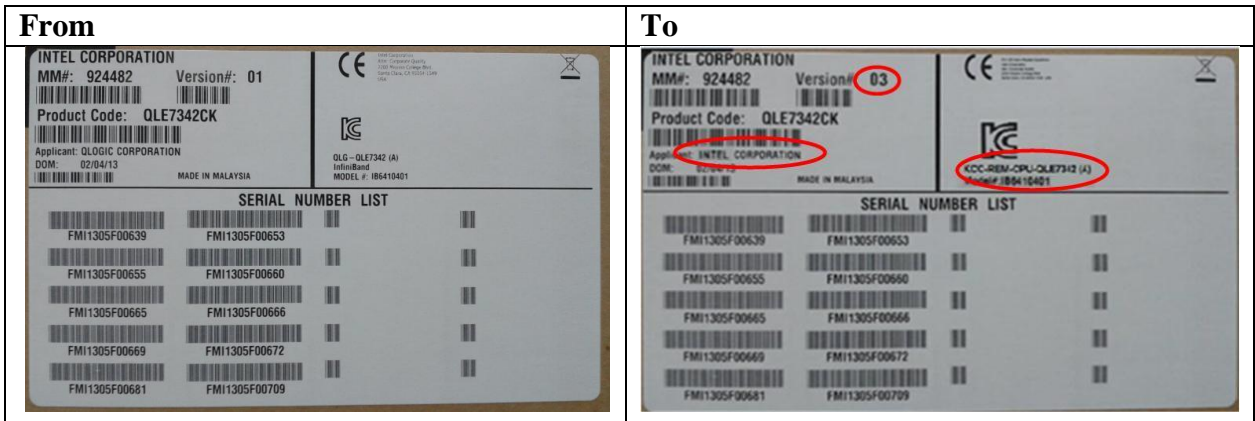
Figure 4. Single Unit Carton Label Changes



### Overpack Carton Label Change Details

- 1) Updated Intel MM version number for both the barcode and human readable element.
- 2) Updated the Korean KC registration number from QLG-QLE7342 (A) to KCC-REM-CPU-QLE7342 (A) and applicant name from QLOGIC CORPORATION to INTEL CORPORATION.

Figure 5. Overpack Carton Label Changes



**Customer Impact of Change and Recommended Action:**

No impacts to fit or function. Minor impacts to form as visible branding and labeling.

There is no change to the Intel MM Number.

Please contact your local Intel Field Sales Representative if you have any further questions about this change.

Milestone dates are estimates and subject to change based on business and operational conditions.

**Products Affected / Intel Ordering Codes:**

Product Code	MM#	Pre Change Top Assembly	Post Change Top Assembly
QLE7342CK	924482	IB6413601-03 Rev G	IB6413601-03 Rev H
QLE7340CK	924483	IB6413601-04 Rev F	IB6413601-04 Rev G
QLE7340LCK	924486	IB6413601-06 Rev E	IB6413601-06 Rev F

**PCN Revision History:**

**Date of Revision:**

June 6, 2013

**Revision Number:**

00

**Reason:**

Originally Published PCN